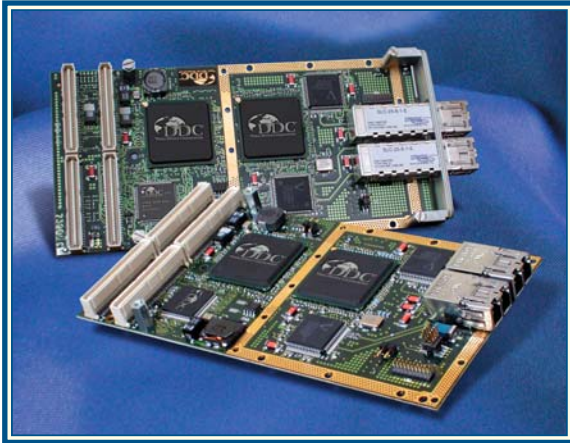


# FibreACCESS™ Fibre Channel Network Access Controller

MODEL: FC-75000 Series



www.ddc-web.com



## FEATURES

- DDC-Developed Technology to Support Long Life Cycles
- Dual-Channel Operation with Failover Options
- Conduction- or Convection-Cooled PMC Card Providing Extended Temperature Operation
- 1 Gb/s or 2 Gb/s Operation
- Class 2 and 3 Service Including Broadcast and Multicast
- 320 MBytes/s Throughput with Memory-to-Memory Latency Under 20  $\mu$ S

## DESCRIPTION

The FC-75000 FibreACCESS™ series are dual redundant Fibre Channel Network Access Controller (NAC) PMC cards optimized for use in military/aerospace applications. The FibreACCESS NAC is suitable for a wide variety of applications for embedded avionics and vetronics systems. These include sensor interfacing, multi-processor and DSP arrays, radar systems, display systems, serial backplanes, and storage.

Based on DDC developed Fibre Channel technology, FibreACCESS is optimized to meet the deterministic performance, high-reliability, and demanding environmental requirements of embedded, real time, military applications. The FibreACCESS FPGA-based architecture can be tailored to meet a wide range of specific system requirements and is not subject to rapidly changing commercial market forces that can result in shortened life cycles. DDC FibreACCESS NACs have been designed to meet the multi-decade life cycle demands of military/aerospace programs, continuing our demonstrated commitment as a long-term military COTS supplier of digital interface devices.

FibreACCESS cards support Class 2 acknowledged and Class 3 unacknowledged Fibre Channel service. The cards provide leading edge performance, with the capability of operating at sustained data rates of over 300 MBytes/s with 2 Gb/s signaling. Built-in DMA engines and 64-bit/66 Mhz PCI initiator/target interface, operating together with the frame, sequence and exchange management controller, autonomously move payload data to and from PCI space. Using host initiated descriptors, frames are assembled and disassembled



# FC-75000 Series Block Diagram

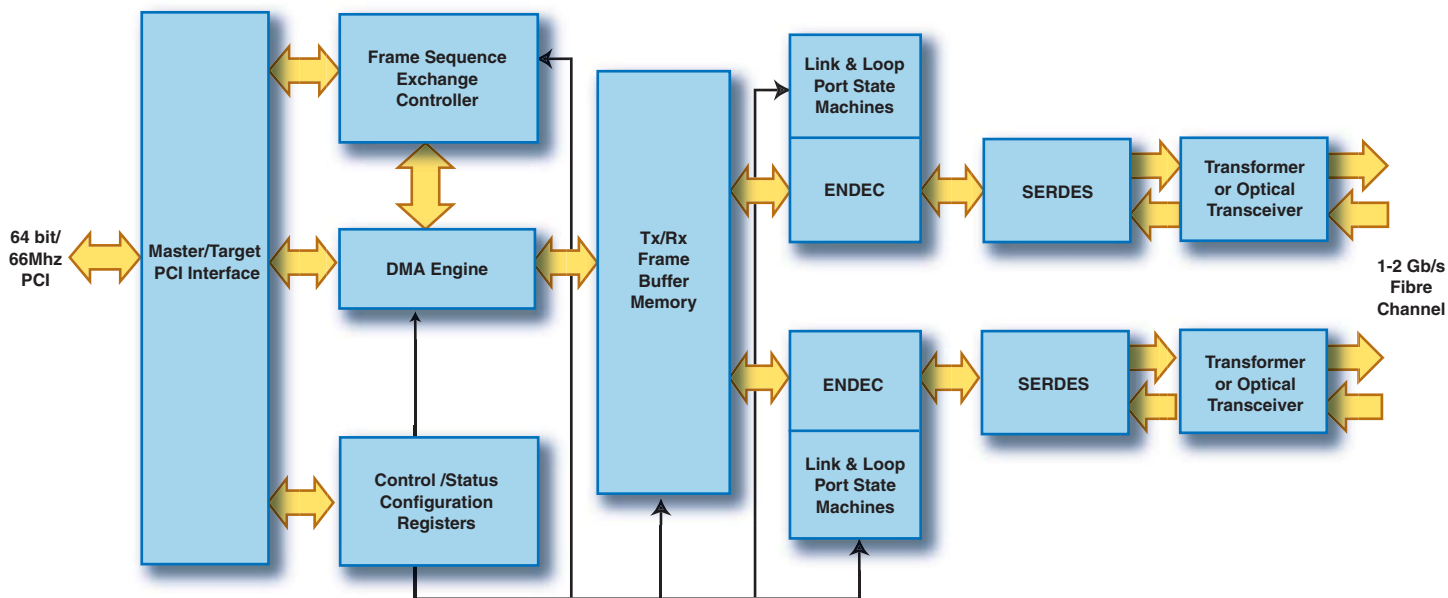


Figure 1 - Block Diagram

## Features

To support the unique requirements of military aerospace applications, the FibreACCESS series includes a number of advanced architectural features such as simultaneous processing of pre-scheduled on-card exchanges, along with high and low priority on-demand exchanges. Other features include autonomous automatic failover; implicit Fibre Channel login; Fibre Channel priority; and ELS clock synchronization.

## Environmental

The FibreACCESS conduction cooled cards are designed to operate in harsh environments at temperatures from -40 °C to +85 °C, and to withstand the mechanical shock and vibration typically found in military/aerospace environments.

## Software Support

Host driver support is available for VxWorks and Linux. Support is provided for ASM, TCP/IP, SCSI Initiator and Raw Mode upper layer protocols. Figure 2 shows the host software layering.

## Physical Layer Options

The FibreACCESS NACs operate at either 1 Gb/s or 2 Gb/s data rates in point-to-point, arbitrated loop or switched fabric topologies. Front panel copper or optical interfaces are supported as well as rear panel copper interfaces. Both standard SFF and compact form factor optical interfaces are available.

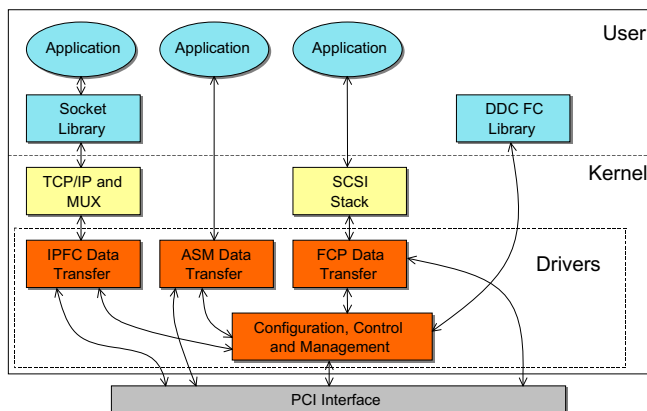


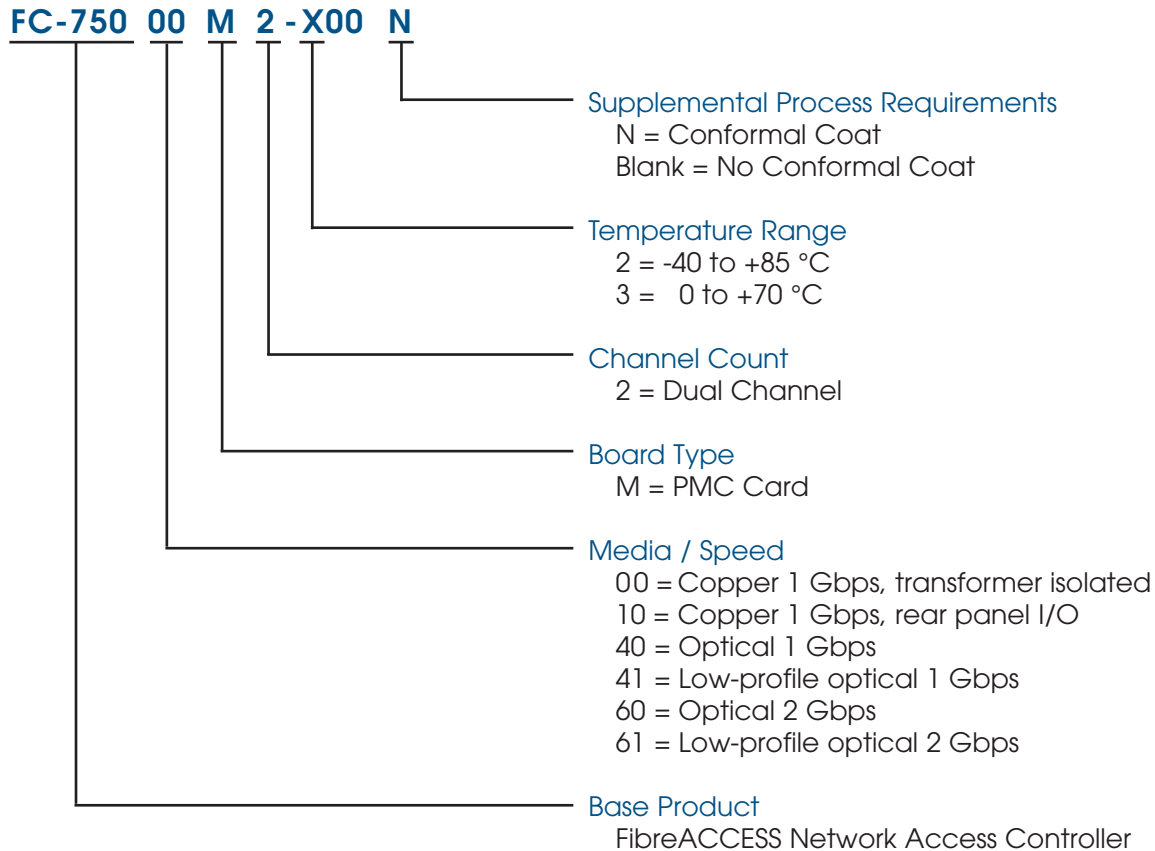
Figure 2 - Software Layering

## Specifications

| PARAMETER                               | MIN               | TYP | MAX  | UNITS | PARAMETER                            | MIN   | TYP | MAX | UNITS |
|---|-------------------|-----|------|-------|--------------------------------------|---|-----|-----|-------|
| <b>ABSOLUTE MAXIMUM RATINGS</b>         |                   |     |      |       | <b>PERFORMANCE CHARACTERISTICS</b>   |   |     |     |       |
| Supply Voltages                         |                   |     |      |       | Throughput                           |   |     |     |       |
| +3.3V                                   | -0.5              |     | 4.0  | V     | Sustained                            |   | 320 |     | MB/s  |
| +5V                                     | -0.3              |     | 6.0  | V     | Peak                                 |   | 400 |     | MB/s  |
| <b>POWER SUPPLY REQUIREMENTS</b>        |                   |     |      |       | End-to-End Latency                   |   |     | 20  | µs    |
| Voltages/Tolerances                     |                   |     |      |       | <b>ENVIRONMENTAL CHARACTERISTICS</b> |   |     |     |       |
| +3.3 V                                  | 3.0               | 3.3 | 3.45 | V     | Humidity                             | 0% to 95% relative humidity (non-condensing)  |     |     |       |
| +5 V                                    | 4.75              | 5.0 | 5.25 | V     | Shock                                | Half-sine, input amplitude of 40 g's, duration of 11 ms, in each of six directions.                         |     |     |       |
| Current Drain                           |                   |     |      |       | Vibration                            | Random input, 15 to 2,000 Hz, overall RMS level of 14g applied for 40 min in each of three orthogonal axes. |     |     |       |
| <u>1 Gb/s Copper</u>                    |                   |     |      |       | <b>PHYSICAL CHARACTERISTICS</b>      |   |     |     |       |
| +3.3V                                   |                   | 394 |      | mA    | Form Factor                          | PMC IEEE P1386.1, ANSI/VITA 20-2001 with secondary thermal interface  |     |     |       |
| +5 V                                    |                   | 860 |      | mA    | Size                                 | 144 x 74 mm (5.659 x 2.913 in)  |     |     |       |
| <u>2 Gb/s Optical</u>                   |                   |     |      |       | Weight                               | 96 g (3.4 oz)   |     |     |       |
| +3.3V                                   |                   | 880 |      | mA    |                                      |   |     |     |       |
| +5 V                                    |                   | 660 |      | mA    |                                      |   |     |     |       |
| <b>THERMAL</b>                          |                   |     |      |       |                                      |   |     |     |       |
| Power Dissipation                       |                   |     |      |       |                                      |   |     |     |       |
| 1 Gb/s Copper                           |                   | 5.6 |      | W     |                                      |   |     |     |       |
| 2 Gb/s Optical                          |                   | 6.2 |      | W     |                                      |   |     |     |       |
| Operating Temperature                   | -40               |     | +85  | °C    |                                      |   |     |     |       |
| Storage Temperature                     | -65               |     | +100 | °C    |                                      |   |     |     |       |
| <b>FIBRE CHANNEL PHYSICAL INTERFACE</b> |                   |     |      |       |                                      |   |     |     |       |
| 1 Gb/s Copper (transformer isolated)    | FC-PI 100-DF-EL-S |     |      |       |                                      |   |     |     |       |
| Link Distance                           |                   |     | 30   | m     |                                      |   |     |     |       |
| 1 Gb/s Optical FC-PI 100-M6-SN-I        |                   |     |      |       |                                      |   |     |     |       |
| Link Distance                           |                   |     | 300  | m     |                                      |   |     |     |       |
| 2 Gb/s Optical FC-PI 200-M6-SN-I        |                   |     |      |       |                                      |   |     |     |       |
| Link Distance                           | 0.5               |     | 150  | m     |                                      |   |     |     |       |

| Features  | Benefits  |
|---|---|
| <b>Physical Layer</b>                           |   |
| 1 Gbs and 2 Gbs signaling rate                  | Flexibility to support multi-speed networks                                   |
| Transformer capacitive coupling (1 Gbps copper) | Provides choice of isolation based on cost-performance requirements           |
| Front panel optical media option                | Greater link distances, reduced cable weight, no EMI                          |
| <b>Topologies Supported</b>                     |   |
| Point-to-point                                  | Simple, supports high throughput  |
| Arbitrated loop                                 | Low cost interconnect topology  |
| Fabric  | Most flexible, high aggregate bandwidth                                       |
| <b>Upper Level Protocols Supported</b>          |   |
| Raw mode  | Lowest overhead, supports mapping of any protocol over Fibre Channel          |
| ASM   | Very low overhead, strong security, supports multicast                        |
| TCP/IP  | Provides compatibility and bridging to standard networks                      |
| SCSI initiator                                  | Provides support for network attached storage                                 |
| <b>Hardware Assist</b>                          |   |
| ASM offload                                     | Maximized throughput while minimizing host loading                            |
| Full duplex segmentation & reassembly           | Supports large sequences, guarantees in-order reception                       |
| Deep Rx and TX frame buffers                    | Maintains performance despite "bursty" traffic and PCI or network bottlenecks |
| Exchange queue                                  | Offloads scheduling from the host, providing deterministic performance        |

## Ordering Information



Note: These products contain tin-lead solder.

| STANDARD DDC PROCESSING<br>FOR DISCRETE MODULES/PC BOARD ASSEMBLIES |           |              |
|---|-----------|--------------|
| TEST  | METHOD(S) | CONDITION(S) |
| INSPECTION/WORKMANSHIP  | IPC-A-610 | Class 3      |
| ELECTRICAL TEST   | DDC ATP   | —            |



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